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APPLICATION NO.	FII	LING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/612,383	07/01/2003		Ka Shing Kenny Kwan	P/4076-54	3682
2352	7590	03/16/2006		EXAMINER	
		ER GERB & SO	JOHNSON, JONATHAN J		
1180 AVENUE OF THE AMERICAS NEW YORK, NY 100368403				ART UNIT	PAPER NUMBER
	•			1725	

DATE MAILED: 03/16/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

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	Application No.	Applicant(s)	
	10/612,383	KWAN ET AL.	
Office Action Summary	Examiner	Art Unit	_
	Jonathan Johnson	1725	
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the c	orrespondence address	
A SHORTENED STATUTORY PERIOD FOR REPLY WHICHEVER IS LONGER, FROM THE MAILING DA - Extensions of time may be available under the provisions of 37 CFR 1.1: after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period v - Failure to reply within the set or extended period for reply will, by statute Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tin will apply and will expire SIX (6) MONTHS from the cause the application to become ABANDONE	N. nely filed the mailing date of this communication. D (35 U.S.C. § 133).	
Status			
Responsive to communication(s) filed on <u>25 Ja</u> This action is FINAL . 2b)⊠ This Since this application is in condition for alloware closed in accordance with the practice under E	action is non-final. nce except for formal matters, pro		
Disposition of Claims			
4) ☐ Claim(s) 1-25 is/are pending in the application. 4a) Of the above claim(s) is/are withdraw 5) ☐ Claim(s) is/are allowed. 6) ☐ Claim(s) 1-13 is/are rejected. 7) ☐ Claim(s) is/are objected to. 8) ☐ Claim(s) 1-25 are subject to restriction and/or example and the second	wn from consideration. election requirement. er. epted or b) □ objected to by the l		
Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the Ex	ion is required if the drawing(s) is ob	jected to. See 37 CFR 1.121(d).	
Priority under 35 U.S.C. § 119			
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority document 2. Certified copies of the priority document 3. Copies of the certified copies of the priority document application from the International Bureau * See the attached detailed Office action for a list	s have been received. s have been received in Applicati rity documents have been receive u (PCT Rule 17.2(a)).	on No ed in this National Stage	
Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail Do 5) Notice of Informal F 6) Other:		

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DETAILED ACTION

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

Claims 1, 2, and 4-13 are rejected under 35 U.S.C. 102(b) as being anticipated by Hisataka (JP 01-296636). Histaka teaches a bump forming device (figure 7, item 7); a chamber system adapted to house the semiconductor devices (Figure 1, item 10); a gas supply for supplying an inert gas into the chamber system (figure 1, item 31); and a support table for supporting the semiconductor devices during bumping, the chamber system having an opening (figure 1, item 10, where the opening extends from item 10 to item 14); a bumping site located adjacent to the opening of the chamber system (figure 1, item 7), said support table being operative to move the semiconductor devices from a bumping site into the chamber system after bumping (figure 1, item 3); at the bumping site the support table being receivable into the chamber system through the opening (figure 1, item 3); including an oxidation reduction device for introducing a supply of inert gas to the bumping site (figure 1, item 31); wherein the bumping site is adjacent to an opening of the chamber system (figure 3, item 17); including a shroud positioned around the bumping site for covering one or more bumped semiconductor devices (figure 1, item 15); wherein the shroud includes nozzles for introducing a supply of inert gas onto the semiconductor devices (figure 1, item 31); wherein the chamber system comprises

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an outer chamber, and an inner chamber that is houseable within the outer chamber (figure 6, items 11 and 2); wherein the inner chamber is removable from the outer chamber (figure 1, items 11 and 2); wherein the removable inner chamber comprises at least a portion of the support table and an inner chamber cover for forming an enclosure around bumped semiconductor devices (figure 1, item 11); including gas tubings that are detachably connectable to the inner chamber for bringing an inert gas into the inner chamber from an external source (figure 1, item 31); wherein the support table is coupled to a positioning device that is operative to move the support table along a first axis (figure 3, x axis); wherein the chamber system is coupled to a positioning device that is operative to move the chamber system along a second axis perpendicular to the first axis (figure 3, y axis); wherein the bump forming device is an ultrasonic wire bonder (abstract); wherein the semiconductor devices are comprised in a semiconductor wafer and the support table capable of supporting a wafer on the table (figure 1, item 3).

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claim 1 is rejected under 35 U.S.C. 103(a) as being unpatentable over Okuyama (DE 3429375) in view of Hisataka (JP 01-296636). Okuyama teaches a chamber system to house the semiconductor device having a access opening (figure 4, item 2); a bump forming device adjacent to the opening and adjacent to the access opening (figure 4, items 1 and 2) and a support

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table for supporting the semiconductor device (figure 4, item 13). Histaka teaches a gas supply for supplying an inert gas into the chamber system (figure 1, item 31). It would have been obvious to one of ordinary skill in the art at the time of the invention to modify the apparatus of Okuyama to utilize the inert gas of Histaka in order to prevent oxidation (see Histaka abstract).

Response to Arguments

In response to applicant's argument that the references fail to show certain features of applicant's invention, it is noted that the features upon which applicant relies (i.e., the bump forming device is located outside of the chamber system) are not recited in the rejected claim(s). Although the claims are interpreted in light of the specification, limitations from the specification are not read into the claims. See *In re Van Geuns*, 988 F.2d 1181, 26 USPQ2d 1057 (Fed. Cir. 1993).

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Jonathan Johnson whose telephone number is 571-272-1177. The examiner can normally be reached on M-Th 7:30 AM-5:30 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Pat Ryan can be reached on 571-272-1292. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Jonathan Johnson Primary Examiner Art Unit 1725